



**RESPONSE UNDER 37 C.F.R. 1.116
EXPEDITED PROCEDURE
EXAMINING GROUP 2815**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Ference et al.

Confirmation No.: 9501

Serial No.: 09/732,240

Group Art Unit: 2815

Filed: 12/07/00

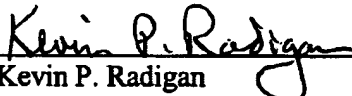
Examiner: Chris C. Chu

Title: MULTI-CHIP STACK AND METHOD OF FABRICATION UTILIZING
SELF-ALIGNING ELECTRICAL CONTACT ARRAY

Q.k.
Enter
C.O.
10/29/04

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with
the U.S. Postal Service as first class mail in an envelope addressed
to: Mail Stop AF, Commissioner for Patents, P.O. Box 1450,
Alexandria, VA 22313-1450, on October 19, 2004.


Kevin P. Radigan
Attorney for Applicants
Registration No.: 31,789

Date of Signature: October 19, 2004.

To: Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Response to Final Office Action

Dear Sir:

This paper is submitted in reply to the final Office Action mailed September 21, 2004, in
connection with the above-designated application. Allowance of all claims is respectfully
requested in view of the amendments to claim 30 and remarks below.

Amendments to the claims begin on page 2 of this paper.

Remarks being on page 5 of this paper.